

# STL128D

# High voltage fast-switching NPN power transistor

## Features

- High voltage capability
- Low spread of dynamic parameters
- Very high switching speed
- Integrated antiparallel collector-emitter diode

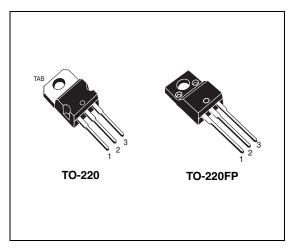
## Applications

- Electronic ballast for fluorescent lighting
- Flyback and forward single transistor low power converters

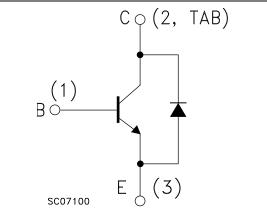
## Description

These devices are high voltage fast-switching NPN power transistors. They are manufactured using high voltage multi epitaxial planar technology for high switching speeds and medium voltage capability.

They use a cellular emitter structure with planar edge termination to enhance switching speeds while maintaining the wide RBSOA. The devices are designed for use in lighting applications and low cost switch-mode power supplies.



### Figure 1. Internal schematic diagram



#### Table 1. Device summary

Order codes Marking		Packages	Packaging
STL128D	L128D	TO-220	Tube
STL128DFP	L128DFP	TO-220FP	Tube

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# 1 Electrical ratings

Symbol	Baramatar	Value		1114	
Symbol	Parameter	TO-220	TO-220FP	Unit	
V <sub>CES</sub>	Collector-emitter voltage (V <sub>BE</sub> = 0)	7(	00	V	
V <sub>CEO</sub>	Collector-emitter voltage (I <sub>B</sub> = 0)	40	400		
V <sub>EBO</sub>	Emitter-base voltage (I <sub>C</sub> = 0)	V <sub>(BF</sub>	I)EBO	V	
Ι <sub>C</sub>	Collector current	4		Α	
I <sub>CM</sub>	Collector peak current (t <sub>P</sub> < 5 ms)	8		А	
I <sub>B</sub>	Base current   2		А		
I <sub>BM</sub>	Base peak current (t <sub>P</sub> < 5 ms)	4		Α	
V <sub>ISOL</sub>	Insulation withstand voltage (RMS) from all three leads to external heatsink		1500	V	
$P_{TOT}$ Total dissipation at T <sub>c</sub> = 25 °C		65	30	W	
T <sub>stg</sub>	Storage temperature	-65 to 150		°C	
TJ	Max. operating junction temperature	150		°C	

### Table 2. Absolute maximum ratings

Symbol	Parameter	Va	Unit		
Symbol	Falameter	TO-220	TO-220FP	Onit	
R <sub>thJ-case</sub>	Thermal resistance junction-case max	1.92	4.17	°C/W	
R <sub>thJ-amb</sub>	Thermal resistance junction-ambient max	62.5		°C/W	



# 2 Electrical characteristics

 $T_{case} = 25 \ ^{\circ}C$  unless otherwise specified

Symbol	Parameter	Test conditions		Min.	Тур.	Max.	Unit
I <sub>CES</sub>	Collector cut-off current (V <sub>BE</sub> = 0)	V <sub>CE</sub> = 700 V V <sub>CE</sub> = 700 V	T <sub>c</sub> = 125 °C			100 500	μΑ μΑ
I <sub>CEO</sub> Collector cut-off current (I <sub>B</sub> = 0)		V <sub>CE</sub> = 400 V				250	μA
V <sub>(BR)EBO</sub> Emitter-base breakdown voltage (I <sub>C</sub> = 0)		I <sub>E</sub> = 10 mA		9		18	V
V <sub>CEO(sus)</sub> <sup>(1)</sup>	Collector-emitter sustaining voltage $(I_B = 0)$	I <sub>C</sub> = 100 mA		400			V
V <sub>CE(sat)</sub> <sup>(1)</sup>	Collector-emitter saturation voltage	$I_{C} = 1 A$ $I_{C} = 2.5 A$ $I_{C} = 3.5 A$	$I_{B} = 0.2 A$ $I_{B} = 0.5 A$ $I_{B} = 0.7 A$		0.5	1 1.5	V V V
V <sub>BE(sat)</sub> <sup>(1)</sup>	Base-emitter saturation voltage	I <sub>C</sub> = 1 A I <sub>C</sub> = 2.5 A	I <sub>B</sub> = 0.2 A I <sub>B</sub> = 0.5 A			1.2 1.3	V V
h <sub>FE</sub> <sup>(1)</sup>	DC current gain	I <sub>C</sub> = 10 mA I <sub>C</sub> = 2 A	V <sub>CE</sub> = 5 V V <sub>CE</sub> = 5 V	10 10		32	
t <sub>s</sub> t <sub>f</sub>	Inductive load Storage time Fall time	$V_{CC} = 200 V$ $I_{B1} = 0.4 A$ $R_{BB} = 0$	I <sub>C</sub> =2 A V <sub>BE(off)</sub> = - 5 V L = 200 μH		0.6 0.1		μs μs

Table 4. Electrical characteristics

1. Pulse test: pulse duration  $\leq$  300 µs, duty cycle  $\leq$  1.5 %.



## 2.1 Electrical characteristics (curves)

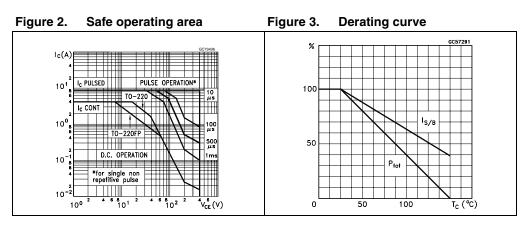
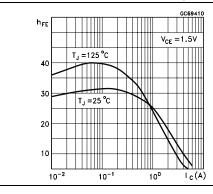
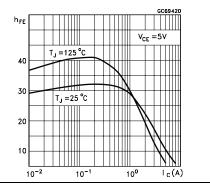
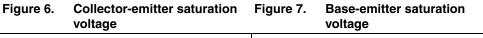
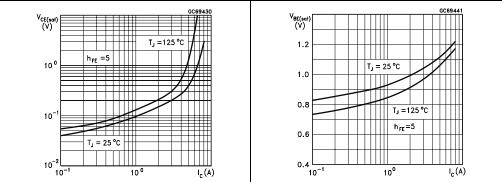


Figure 4. DC current gain ( $V_{CE} = 1.5 V$ ) Figure 5. DC current gain ( $V_{CE} = 5 V$ )





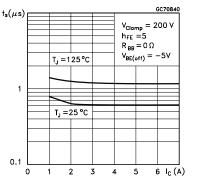




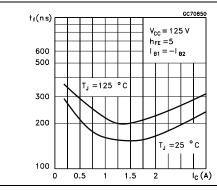


#### Figure 8. GC70830 t<sub>f</sub>(ns) $t_s(\mu s)$ $V_{Clamp} = 200 V$ hre =5 R<sub>BB</sub> = 0 Ω V<sub>BE(off)</sub> = -5V T<sub>J</sub> = 125 °C 100 1 T<sub>J</sub> = 25 °C 10 0.1 0 1 2 3 4 5 6 I<sub>C</sub>(A) 0 1 2

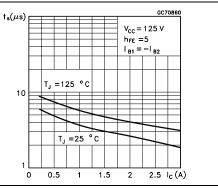
#### Inductive load fall time Figure 9. Inductive load storage time



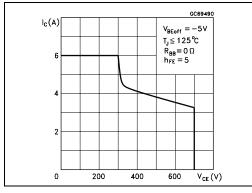














# 3 Package mechanical data

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK® specifications, grade definitions and product status are available at: www.st.com. ECOPACK is an ST trademark.

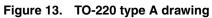


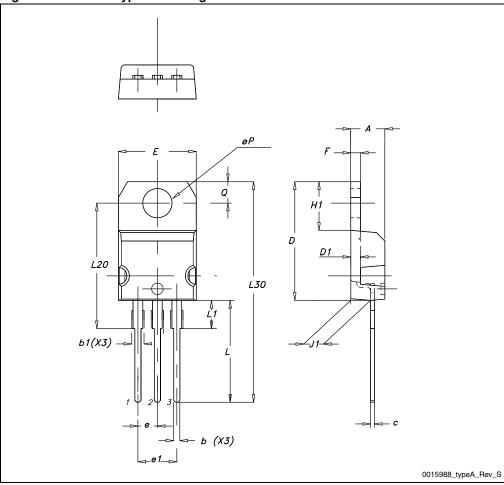
Dim	mm				
Dim. —	Min.	Тур.	Max.		
A	4.40		4.60		
b	0.61		0.88		
b1	1.14		1.70		
с	0.48		0.70		
D	15.25		15.75		
D1		1.27			
E	10		10.40		
е	2.40		2.70		
e1	4.95		5.15		
F	1.23		1.32		
H1	6.20		6.60		
J1	2.40		2.72		
L	13		14		
L1	3.50		3.93		
L20		16.40			
L30		28.90			
ØР	3.75		3.85		
Q	2.65		2.95		

Table 5. TO-220 type A mechanical data

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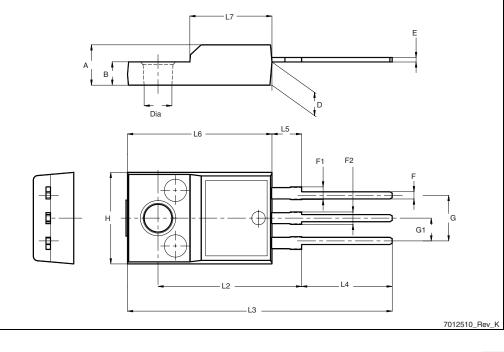




Dim	mm.			
Dim. —	Min.	Тур.	Max.	
Α	4.4		4.6	
В	2.5		2.7	
D	2.5		2.75	
E	0.45		0.7	
F	0.75		1	
F1	1.15		1.70	
F2	1.15		1.70	
G	4.95		5.2	
G1	2.4		2.7	
н	10		10.4	
L2		16		
L3	28.6		30.6	
L4	9.8		10.6	
L5	2.9		3.6	
L6	15.9		16.4	
L7	9		9.3	
Dia	3		3.2	

Table 6. TO-220FP mechanical data

## Figure 14. TO-220FP drawing



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# 4 Revision history

## Table 7.Document revision history

Date	Revision	Changes
27-Jun-2011	1	First release



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